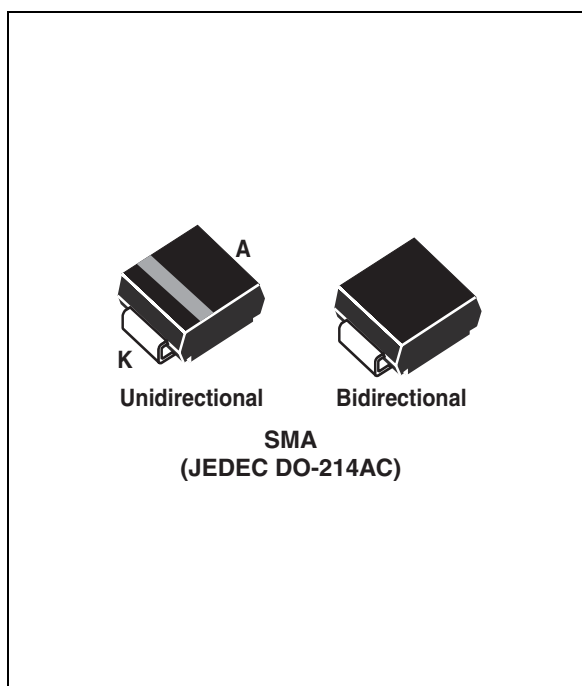


Features

- Peak pulse power:
 - 400 W (10/1000 μ s)
 - 2.3 kW (8/20 μ s)
- Stand off voltage range: from 5 V to 188 V
- Unidirectional and bidirectional types
- Low leakage current:
 - 0.2 μ A at 25 °C
 - 1 μ A at 85 °C
- Operating T_j max: 150 °C
- High power capability at T_{jmax} :
 - 270 W (10/1000 μ s)
- JEDEC registered package outline

Complies with the following standards

- IEC 61000-4-2 level 4
 - 15 kV (air discharge)
 - 8 kV (contact discharge)
- IEC 61000-4-5 (see [Table 3](#) for surge level)
- MIL STD 883G, method 3015-7 Class 3B
 - 25 kV HBM (human body model)
- Resin meets UL 94, V0
- MIL-STD-750, method 2026 solderability
- EIA STD RS-481 and IEC 60286-3 packing
- IPC 7531 footprint



Description

The SMAJ Transil series has been designed to protect sensitive equipment against electrostatic discharges according to IEC 61000-4-2, and MIL STD 883, method 3015, and electrical over stress according to IEC 61000-4-4 and 5. These devices are generally used against surges below 400 W (10/1000 μ s).

Planar technology makes these devices suitable for high-end equipment and SMPS where low leakage current and high junction temperature are required to provide reliability and stability over time.

SMAJ are packaged in SMA (SMA footprint in accordance with IPC 7531 standard).

TM: Transil is a trademark of STMicroelectronics

1 Characteristics

Table 1. Absolute maximum ratings ($T_{amb} = 25\text{ }^{\circ}\text{C}$)

Symbol	Parameter	Value	Unit
P_{PP}	Peak pulse power dissipation ⁽¹⁾ T_j initial = T_{amb}	400	W
T_{stg}	Storage temperature range	-65 to +150	$^{\circ}\text{C}$
T_j	Operating junction temperature range	-55 to +150	$^{\circ}\text{C}$
T_L	Maximum lead temperature for soldering during 10 s.	260	$^{\circ}\text{C}$

1. For a surge greater than the maximum values, the diode will fail in short-circuit.

Table 2. Thermal resistances

Symbol	Parameter	Value	Unit
$R_{th(j-l)}$	Junction to leads	30	$^{\circ}\text{C/W}$
$R_{th(j-a)}$	Junction to ambient on printed circuit on recommended pad layout	120	$^{\circ}\text{C/W}$

Figure 1. Electrical characteristics - definitions

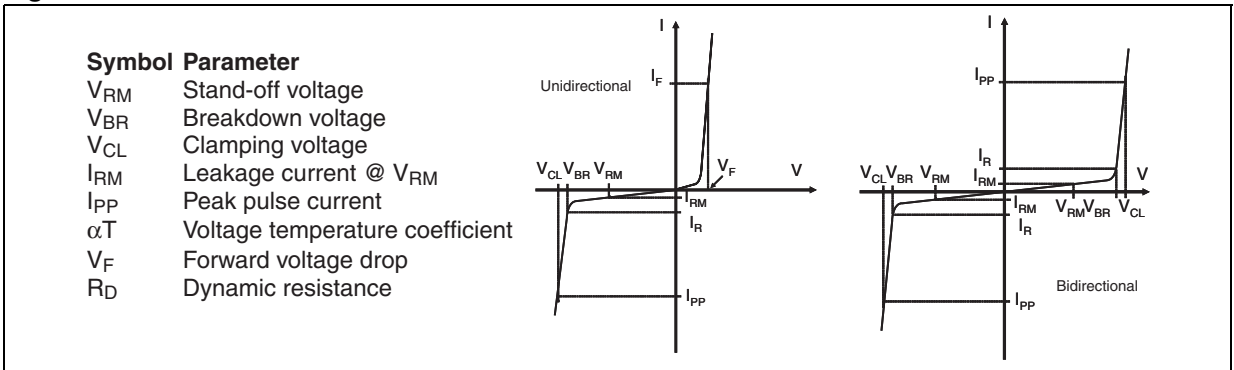


Figure 2. Pulse definition for electrical characteristics

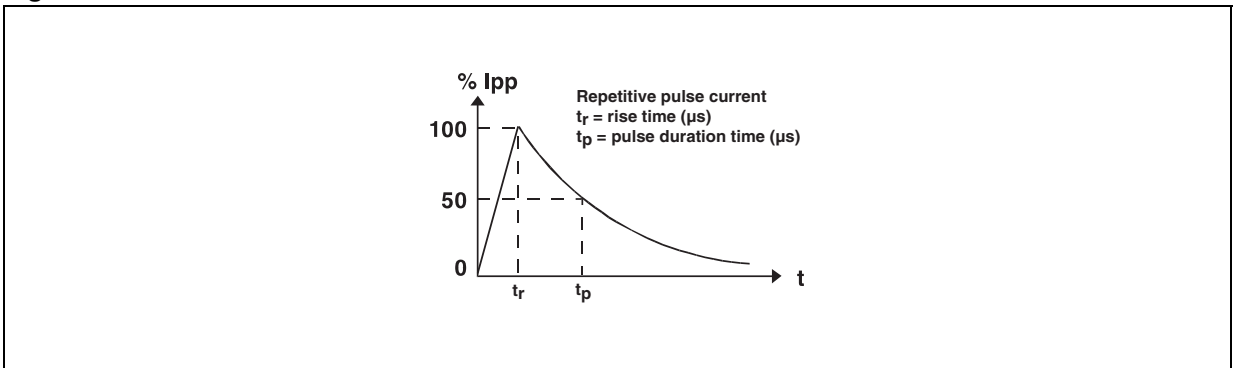


Table 3. Electrical characteristics - parameter values ($T_{amb} = 25\text{ }^{\circ}\text{C}$)

Order code	$I_{RM} \text{ max}@V_{RM}$			$V_{BR} @I_R^{(1)}$			$V_{CL} @I_{PP}$ 10/1000 μs		$R_D^{(2)}$ 10/1000 μs	$V_{CL} @I_{PP}$ 8/20 μs		$R_D^{(2)}$ 8/20 μs	$\alpha T^{(3)}$
	25 $^{\circ}\text{C}$	85 $^{\circ}\text{C}$		min	typ		max			max			max
	μA		V	V		mA	V	A ⁽⁴⁾	Ω	V	A ⁽⁴⁾	Ω	10-4/ $^{\circ}\text{C}$
SMAJ5.0A/CA	20	50	5	6.4	6.74	10	9.2	43.5	0.049	13.4	174	0.036	5.7
SMAJ6.0A/CA	20	50	6	6.7	7.05	10	10.3	38.8	0.075	13.7	170	0.037	5.9
SMAJ6.5A/CA	20	50	6.5	7.2	7.58	10	11.2	35.7	0.091	14.5	160	0.041	6.1
SMAJ8.5A/CA	20	50	8.5	9.4	9.9	1	14.4	27.7	0.145	19.5	124	0.073	7.3
SMAJ10A/CA	0.2	1	10	11.1	11.7	1	17	23.5	0.201	21.7	106	0.089	7.8
SMAJ12A/CA	0.2	1	12	13.3	14	1	19.9	20.1	0.259	25.3	91	0.116	8.3
SMAJ13A/CA	0.2	1	13	14.4	15.2	1	21.5	18.6	0.298	27.2	85	0.132	8.4
SMAJ15A/CA	0.2	1	15	16.7	17.6	1	24.4	16.4	0.361	32.5	71	0.197	8.8
SMAJ18A/CA	0.2	1	18	20	21.1	1	29.2	13.7	0.514	39.3	59	0.291	9.2
SMAJ20A/CA	0.2	1	20	22.2	23.4	1	32.4	12.3	0.637	42.8	54	0.338	9.4
SMAJ22A/CA	0.2	1	22	24.4	25.7	1	35.5	11.2	0.760	48.3	48	0.444	9.6
SMAJ24A/CA	0.2	1	24	26.7	28.1	1	38.9	10.3	0.912	50	46	0.446	9.6
SMAJ26A/CA	0.2	1	26	28.9	30.4	1	42.1	9.5	1.07	53.5	43	0.502	9.7
SMAJ28A/CA	0.2	1	28	31.1	32.7	1	45.4	8.8	1.26	59	39	0.632	9.8
SMAJ30A/CA	0.2	1	30	33.3	35.1	1	48.4	8.3	1.39	64.3	36	0.762	9.9
SMAJ33A/CA	0.2	1	33	36.7	38.6	1	53.3	7.5	1.70	69.7	33	0.884	10
SMAJ40A/CA	0.2	1	40	44.4	46.7	1	64.5	6.2	2.49	84	27	1.30	10.1
SMAJ43A/CA	0.2	1	43	47.8	50.3	1	69.4	5.7	2.91	91	25	1.53	10.2
SMAJ48A/CA	0.2	1	48	53.3	56.1	1	77.4	5.2	3.56	100	23	1.79	10.3
SMAJ58A/CA	0.2	1	58	64.4	67.8	1	93.6	4.3	5.21	121	19	2.62	10.4
SMAJ70A/CA	0.2	1	70	77.8	81.9	1	113	3.5	7.72	146	16	3.75	10.5
SMAJ85A/CA	0.2	1	85	94	99	1	137	2.9	11.4	178	13	5.70	10.6
SMAJ100A/CA	0.2	1	100	111	117	1	162	2.5	15.7	212	11	8.10	10.7
SMAJ130A/CA	0.2	1	130	144	152	1	209	1.9	26.0	265	9	11.7	10.8
SMAJ154A/CA	0.2	1	154	171	180	1	246	1.6	35.6	317	7	18.3	10.8
SMAJ170A/CA	0.2	1	170	189	199	1	275	1.4	47.2	353	6.5	22.2	10.8
SMAJ188A/CA	0.2	1	188	209	220	1	328	1.4	69.3	388	6	26.2	10.8

1. Pulse test : $t_p < 50\text{ ms}$
2. To calculate maximum clamping voltage at other surge level, use the following formula: $V_{CLmax} = V_{CL} - R_D \times (I_{PP} - I_{PPappli})$
where $I_{PPappli}$ is the surge current in the application
3. To calculate V_{BR} or V_{CL} versus junction temperature, use the following formulas:

$$V_{BR} @ T_J = V_{BR} @ 25^{\circ}\text{C} \times (1 + \alpha T \times (T_J - 25)),$$

$$V_{CL} @ T_J = V_{CL} @ 25^{\circ}\text{C} \times (1 + \alpha T \times (T_J - 25))$$
4. Surge capability given for both directions for unidirectional and bidirectional types.

Figure 3. Peak pulse power dissipation versus initial junction temperature

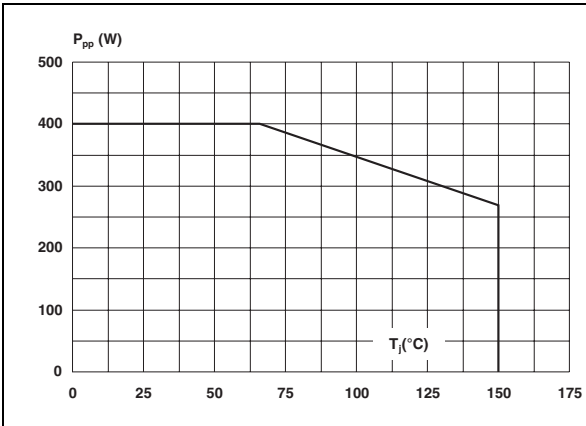


Figure 4. Peak pulse power versus exponential pulse duration (T_j initial = 25° C)

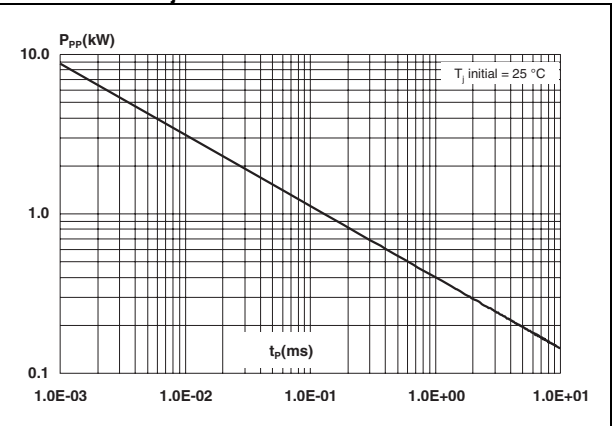


Figure 5. Clamping voltage versus peak pulse current (exponential waveform, maximum values)

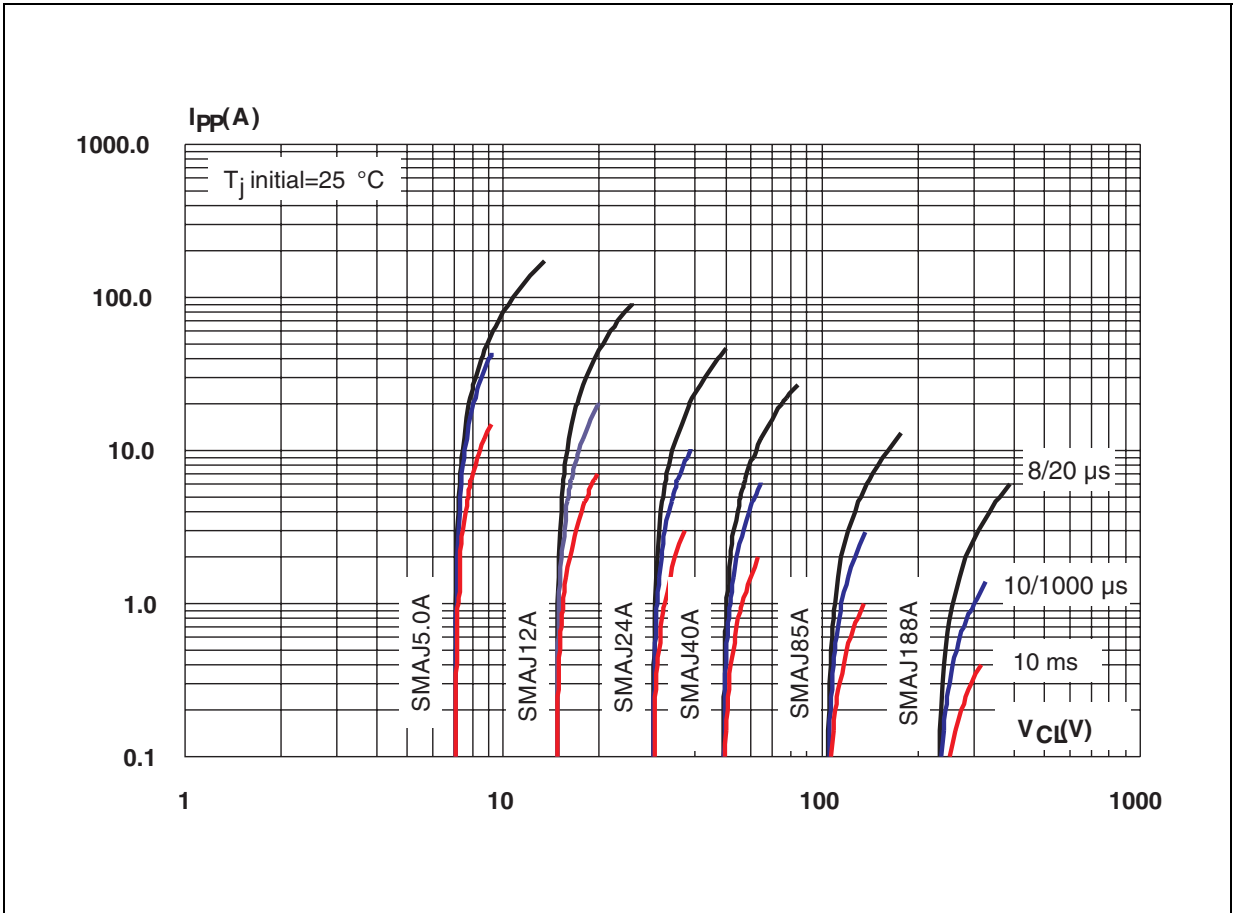


Figure 6. Junction capacitance versus reverse applied voltage for unidirectional types (typical values)

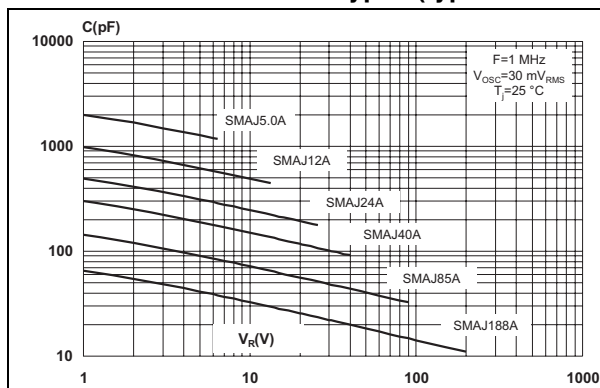


Figure 7. Junction capacitance versus reverse applied voltage for bidirectional types (typical values)

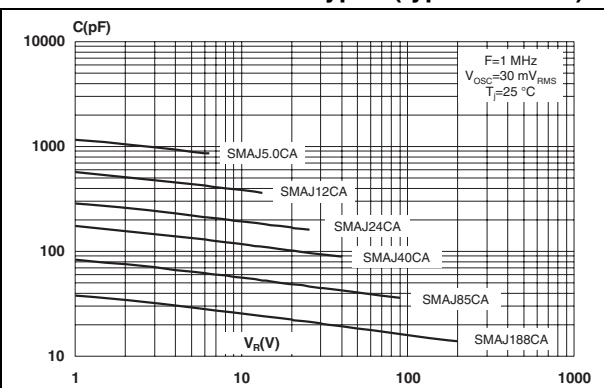


Figure 8. Peak forward voltage drop versus peak forward current (typical values)

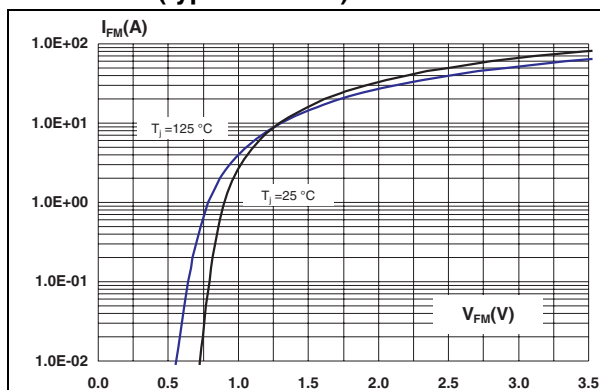


Figure 9. Relative variation of thermal impedance, junction to ambient, versus pulse duration

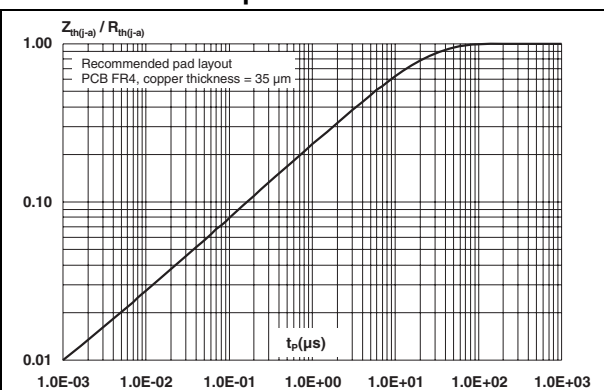


Figure 10. Thermal resistance, junction to ambient, versus copper surface under each lead

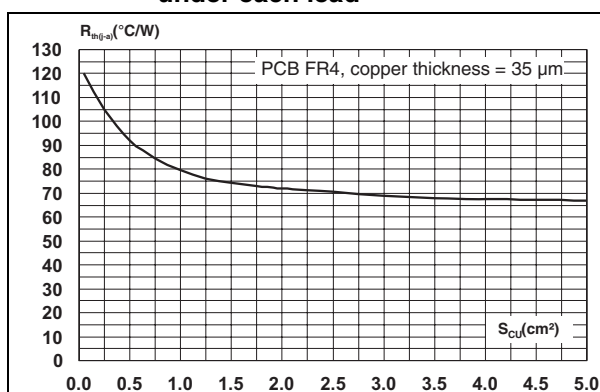
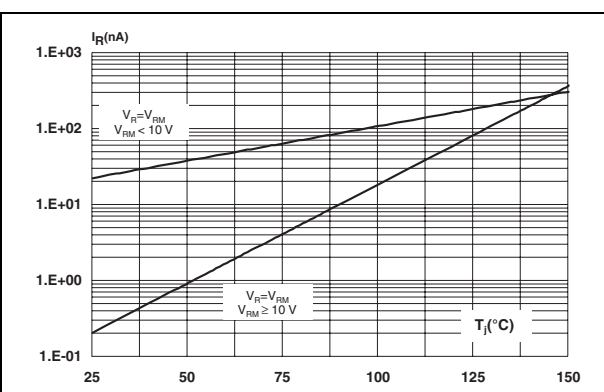
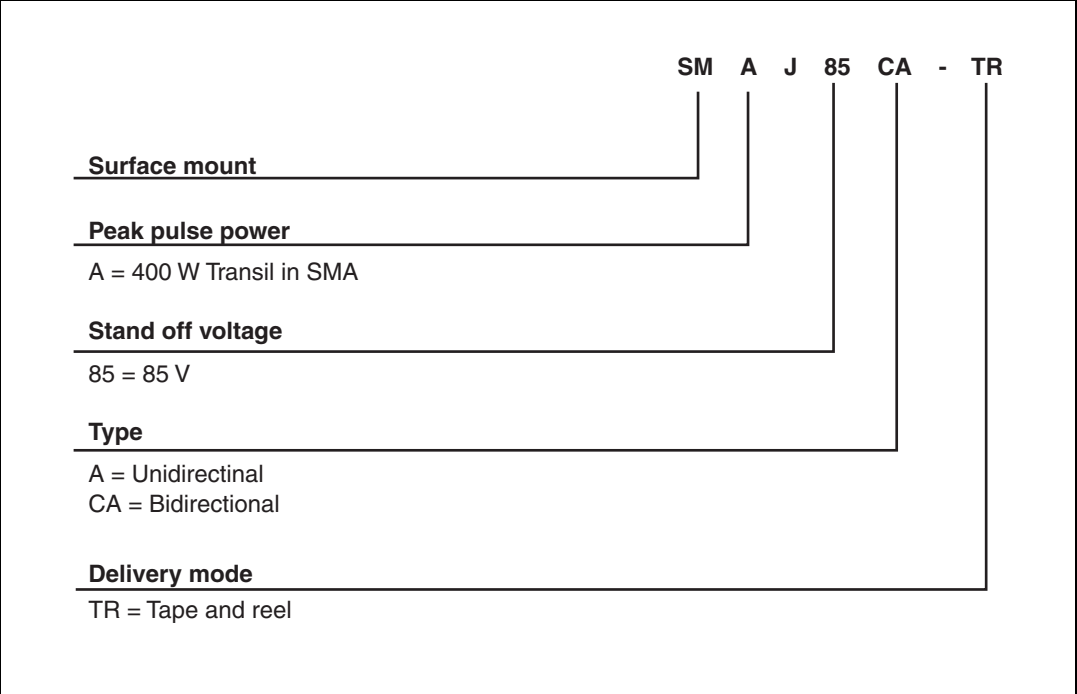


Figure 11. Leakage current versus junction temperature (typical values)



2 Ordering information scheme

Figure 12. Ordering information scheme



3 Package information

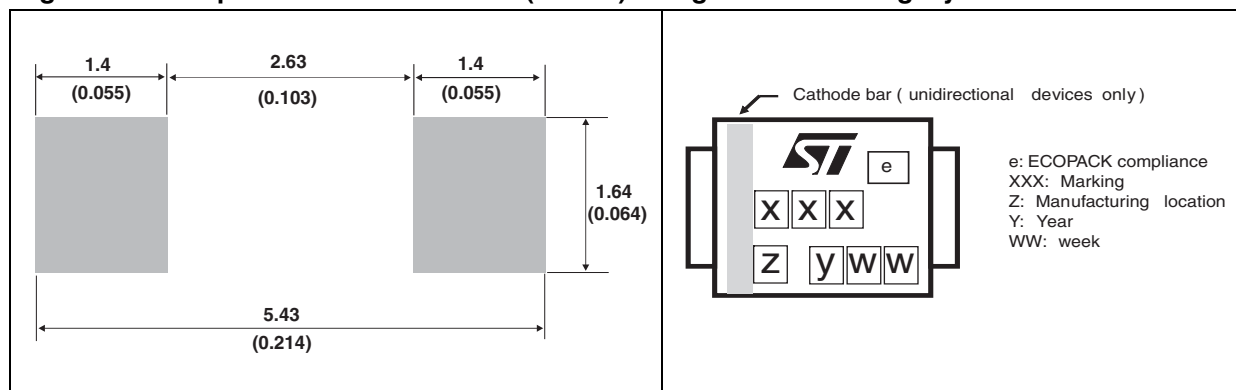
- Case: JEDEC DO-214AC molded plastic over planar junction
- Terminals: solder plated, solderable per MIL-STD-750, Method 2026
- Polarity: for unidirectional types the band indicates cathode.
- Flammability: epoxy is rated UL94V-0
- RoHS package

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

Table 4. SMA dimensions

Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A1	1.90	2.45	0.075	0.094
A2	0.05	0.20	0.002	0.008
b	1.25	1.65	0.049	0.065
c	0.15	0.40	0.006	0.016
D	2.25	2.90	0.089	0.114
E	4.80	5.35	0.189	0.211
E1	3.95	4.60	0.156	0.181
L	0.75	1.50	0.030	0.059

Figure 13. Footprint dimensions in mm (inches) **Figure 14. Marking layout⁽¹⁾**



1. Marking layout can vary according to assembly location.

Table 5. Marking

Order code	Marking	Order code	Marking
SMAJ5.0A-TR	AE	SMAJ5.0CA-TR	AA
SMAJ6.0A-TR	DUB	SMAJ6.0CA-TR	DBB
SMAJ6.5A-TR	DUC	SMAJ6.5CA-TR	DBC
SMAJ8.5A-TR	DUH	SMAJ8.5CA-TR	DBH
SMAJ10A-TR	AX	SMAJ10CA-TR	AC
SMAJ12A-TR	DUK	SMAJ12CA-TR	DBK
SMAJ13A-TR	BG	SMAJ13CA-TR	BH
SMAJ15A-TR	BM	SMAJ15CA-TR	AJ
SMAJ18A-TR	DUQ	SMAJ18CA-TR	DBQ
SMAJ20A-TR	DUR	SMAJ20CA-TR	DBR
SMAJ22A-TR	DUS	SMAJ22CA-TR	DBS
SMAJ24A-TR	DUT	SMAJ24CA-TR	DBT
SMAJ26A-TR	DUU	SMAJ26CA-TR	DBU
SMAJ28A-TR	CG	SMAJ28CA-TR	CH
SMAJ30A-TR	CK	SMAJ30CA-TR	CL
SMAJ33A-TR	CM	SMAJ33CA-TR	CN
SMAJ40A-TR	DUZ	SMAJ40CA-TR	DBZ
SMAJ43A-TR	EUA	SMAJ43CA-TR	EBA
SMAJ48A-TR	CX	SMAJ48CA-TR	CY
SMAJ58A-TR	EUF	SMAJ58CA-TR	EBF
SMAJ70A-TR	EUI	SMAJ70CA-TR	EBI
SMAJ85A-TR	EUL	SMAJ85CA-TR	EBL
SMAJ100A-TR	EUN	SMAJ100CA-TR	EBN
SMAJ130A-TR	EUQ	SMAJ130CA-TR	EBQ
SMAJ154A-TR	EUT	SMAJ154CA-TR	EBT
SMAJ170A-TR	SR	SMAJ170CA-TR	SS
SMAJ188A-TR	EUV	SMAJ188CA-TR	EBV

4 Ordering information

Table 6. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
SMAJxxxA/CA-TR ⁽¹⁾	See Table 5 on page 8	SMA	0.071 g	5000	Tape and reel

1. Where xxx is nominal value of V_{BR} and A or CA indicates unidirectional or bidirectional version. See [Table 3](#) for list of available devices and their order codes

5 Revision history

Table 7. Document revision history

Date	Revision	Changes
September-1998	5B	Previous update.
02-Aug-2004	6	SMA package dimensions update. Reference A1 max. changed from 2.70mm (0.106) to 2.03mm (0.080).
10-Dec-2004	7	Template layout update. No content change.
10-Feb-2006	8	Added unidirectional marking on cover page and Figure 14. Changed Figure 13. Foot print.
14-May-2009	9	Updated ECOPACK statement. Reformatted to current standards.
17-Sep-2009	10	Document updated for low leakage current.
05-Nov-2009	11	Corrected typographical error in Package information .

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